

Geant4 Evaluation and Optimization of Portable Faraday Cup

Overview

- Evaluation (% charge defect [%cd])
 - HIT, Geant4
- Optimization
 - MCNP6: Height, Radius
 - Geant4: film thickness, %cd minimization
- Validation
 - G4 Energy Spectra, go99 branching ratios
- Discussion
 - Dosimetric quiver plot, Deposition Histogram

Evaluation

$$\text{Charge defect} = ([q_{\text{in}} - q_{\text{out}}] - q_{\text{beam}})/q_{\text{beam}}$$

- Assumption:

Deposition/Removal of charge in Kapton produces mirror charge in Copper with magnitude linearly proportional to depth in Kapton between Copper and Silver interfaces

Evaluation

Experimental vs. Simulated Beam Stop % charge defect

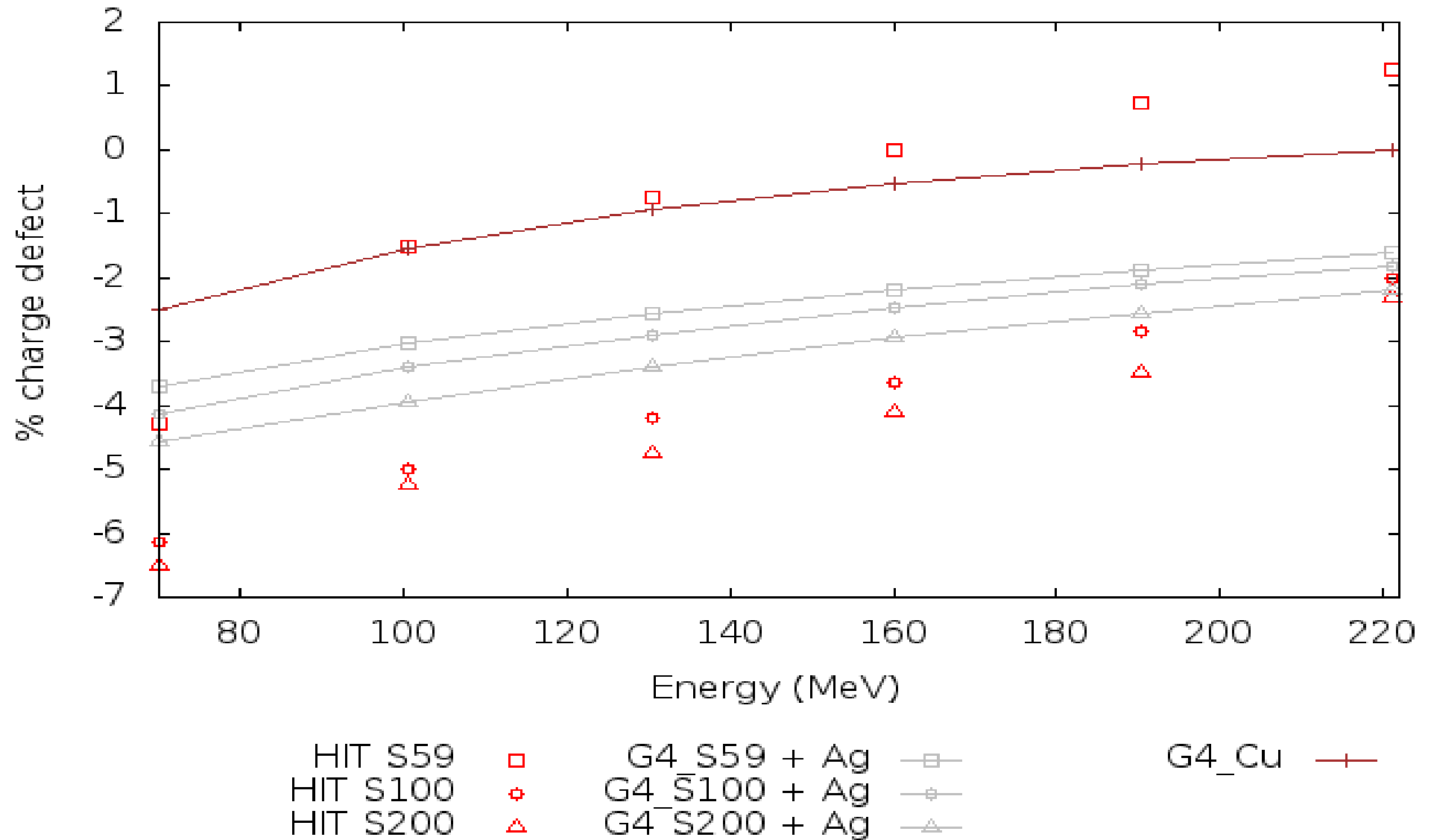


Fig 1: Comparison of Geant4 and HIT Experimental charge defect measurements

Optimization

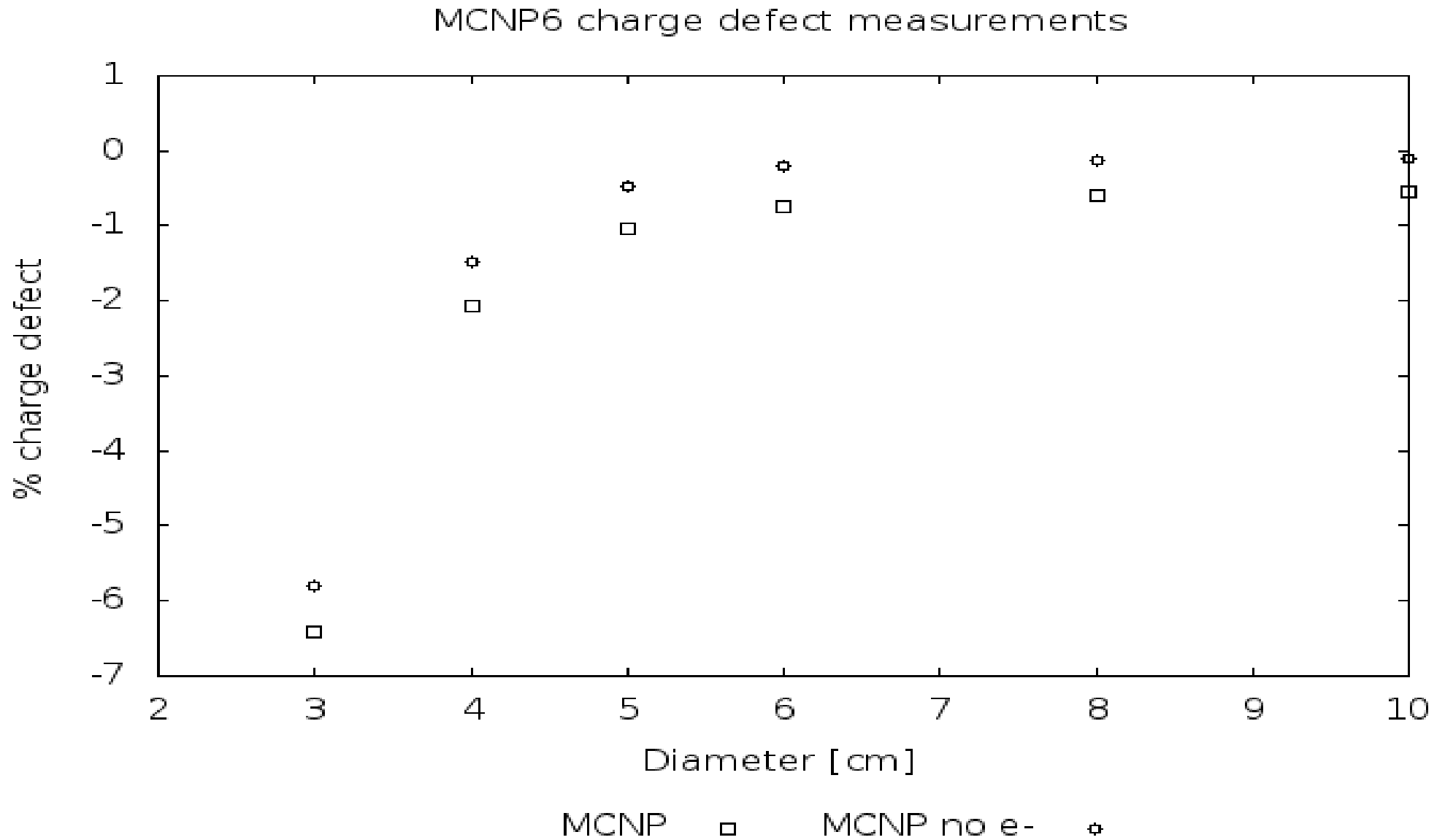


Fig 2: Charge defect measurement for coarse device dimension optimization

Optimization

- Goal: Minimize $|\%cd|$ by fine-tuning dimensions
- Thus:
 - Obtain functional Kapton thickness of energy such that $[\%cd](E=X, t_{KA}=Y) = 0$
 - Preliminary results show $Y=36$ microns when $X=160$ MeV

Validation

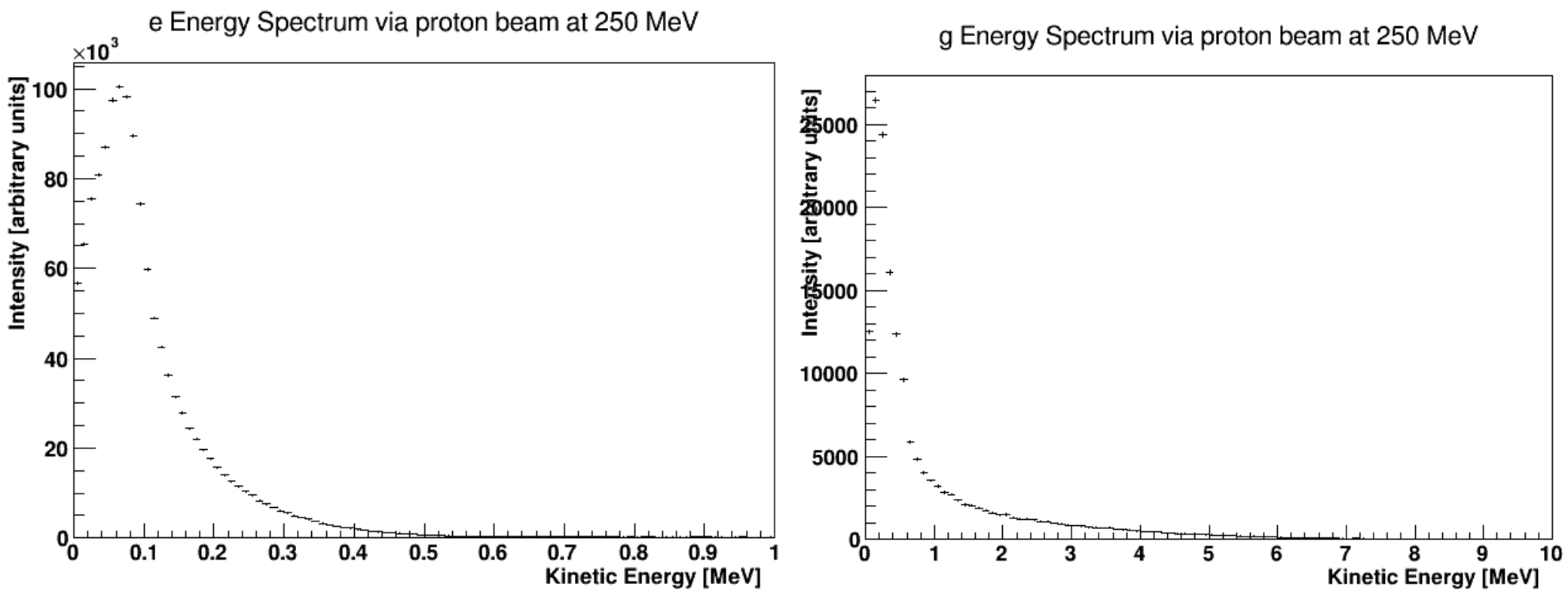


Fig 3: a) Beta spectra and b) gamma spectra in Copper via Geant4

Discussion

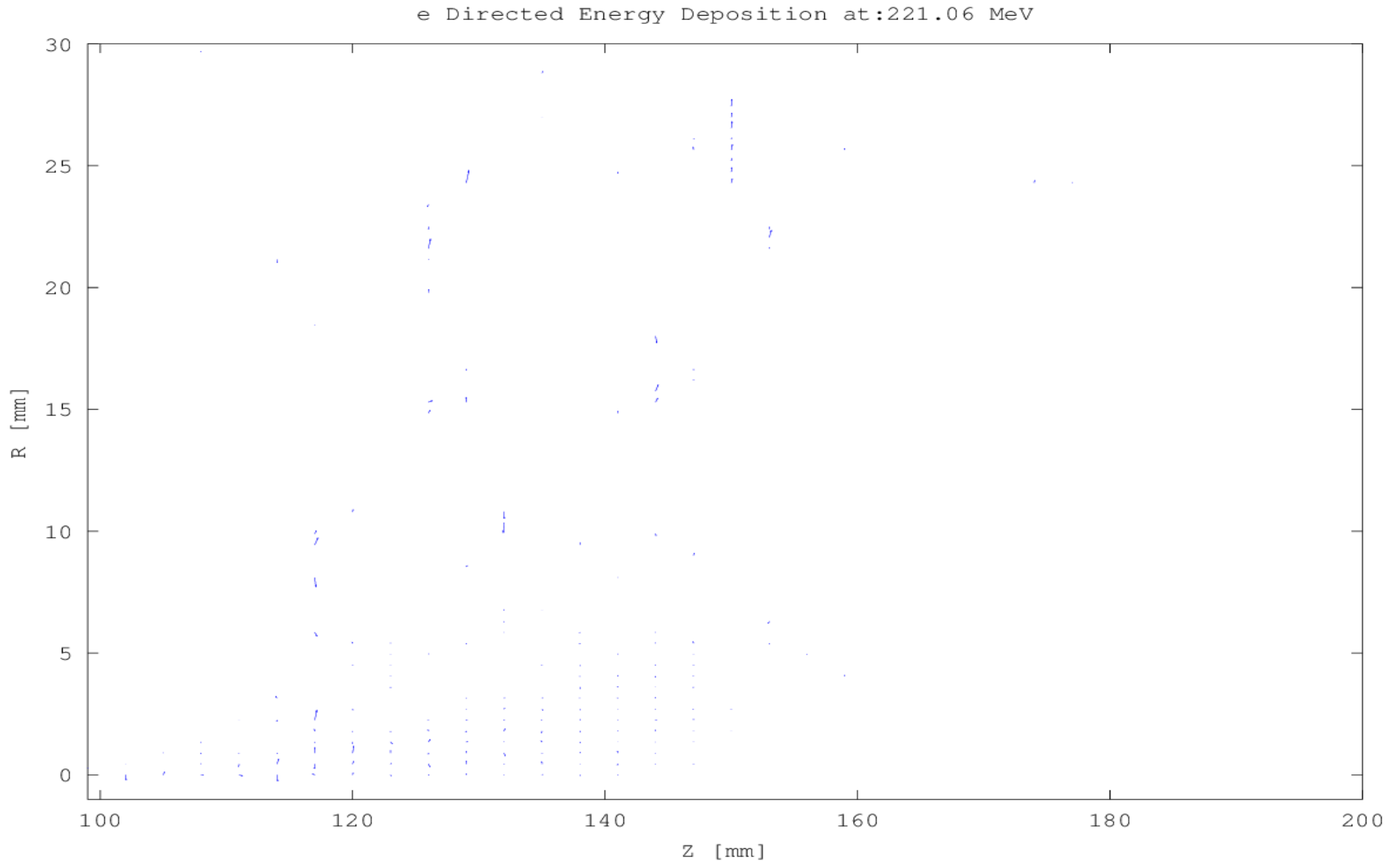


Fig 4: Energy deposition gradient for electrons via Geant4; note both spray and halo/aura presence

Discussion

p Cu distribution at 250 MeV

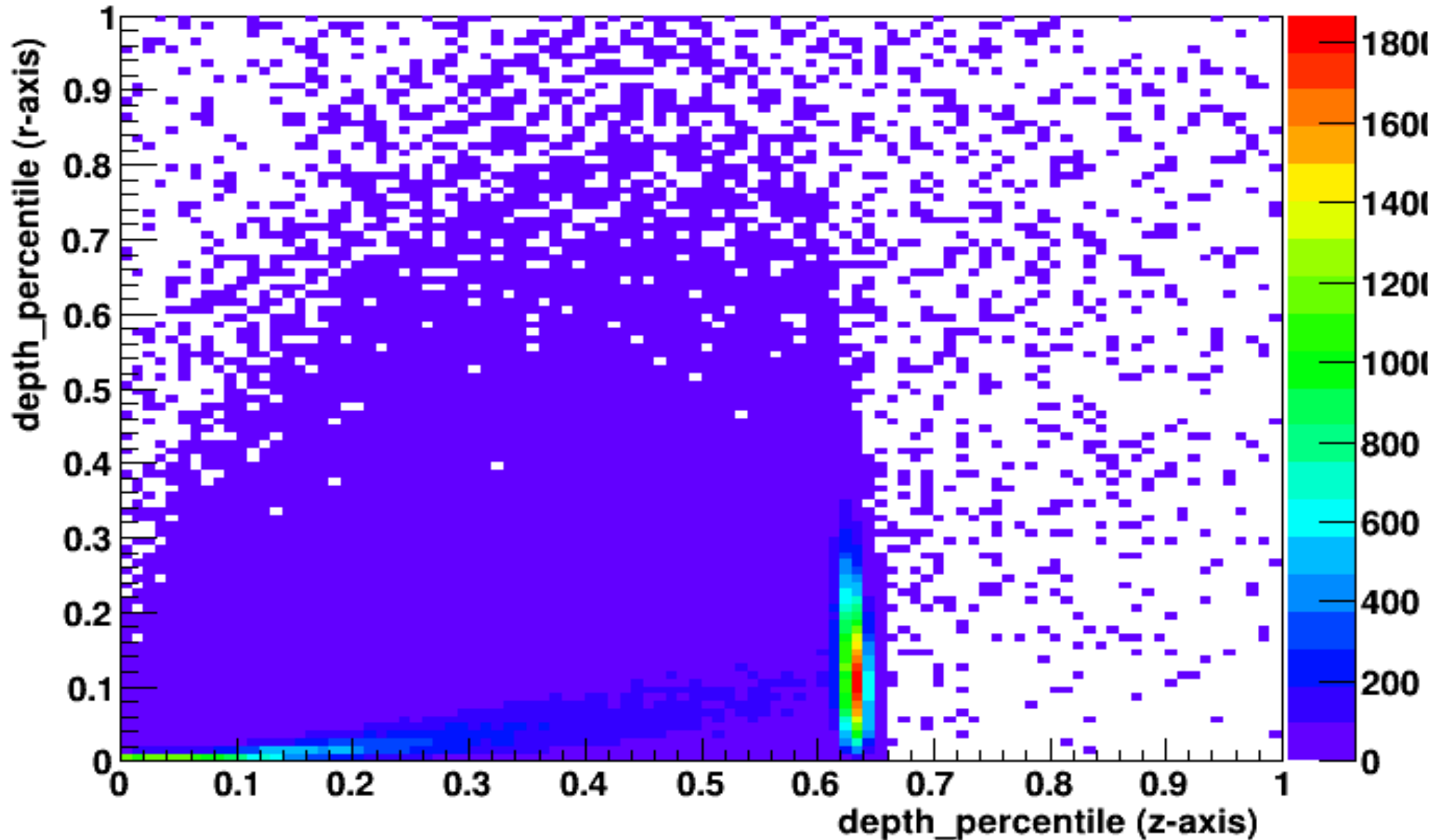


Fig 5: Proton deposition count in Copper via Geant4

Discussion

n Cu distribution at 250 MeV

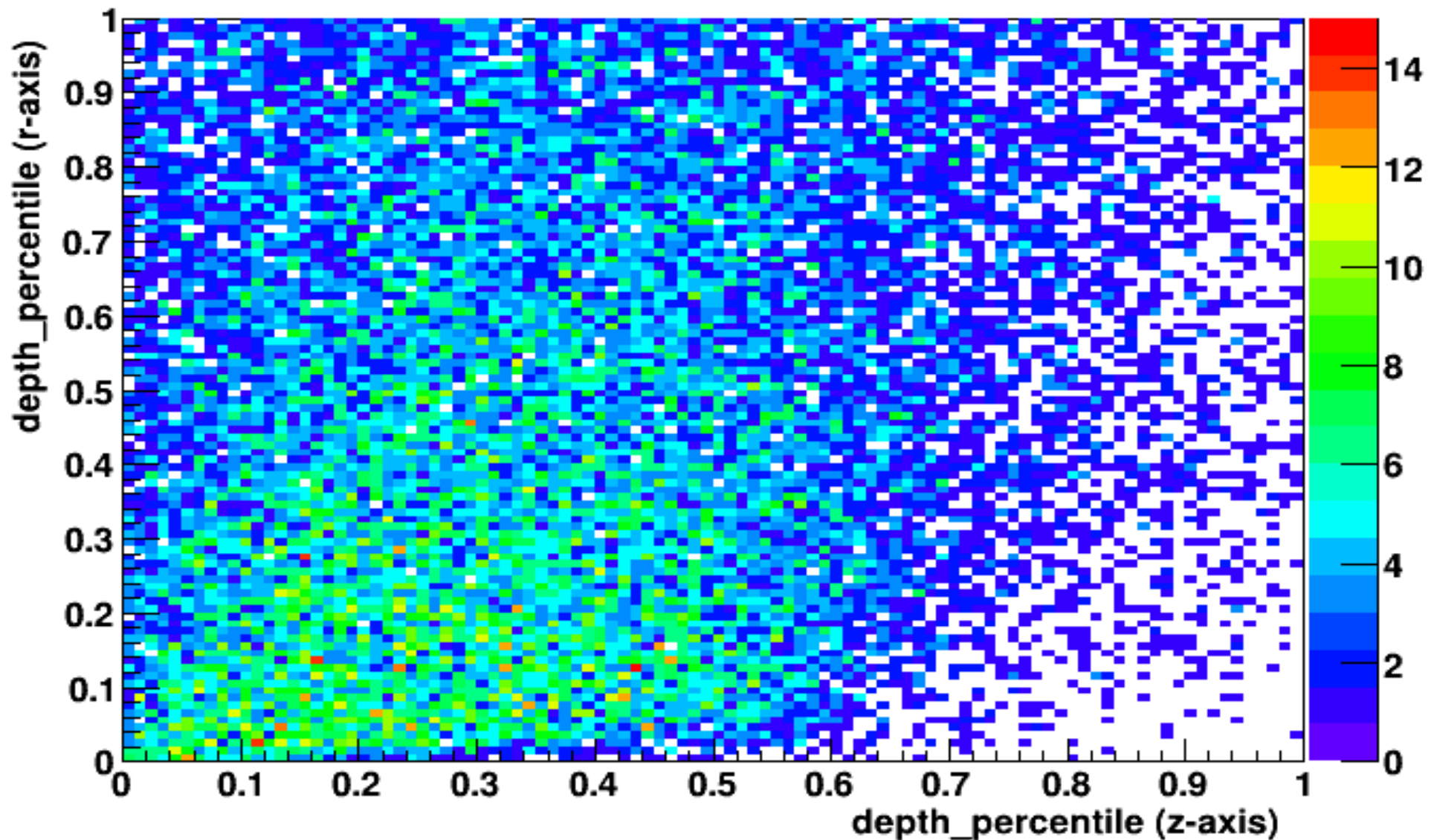


Fig 5: Neutron deposition count in Copper via Geant4